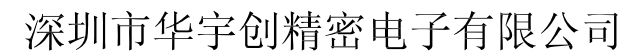


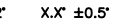
1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE t=0.35mm.
3. PLATING :SELECTING GOLD PLATING 3u"~50u" OVER
NICKEL IN CONTACT AREA. 150u" TIN
PLATING OVER NICKEL IN SOLDER AREA

1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE
:1000V AC RMS 50Hz. 1MIN.

1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.



TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣		DATE : 2014-02-23		PART NAME: RJ45 1X2并排 180 ° DIP 全塑	
 UNIT: mm [inch]		CHECKED BY: 马跃		DATE : 2014-02-23		PART NO. HYCW99-RJ45-150B	
		APPROVED BY: 邱国夷		DATE : 2014-02-23		MOLD NO. 	
SCALE:1:1 SIZE: A4				DRAW NO: HYC-RJ17032909		SHEET NO. 1 OF 1	